

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
BIAO QIN	11/18/2016
RECEIVING PARTY DATA	
Name:	SHENZHEN QIN BO CORE TECHNOLOGY DEVELOPMENT CO., LTD.
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State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13636661
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NAME OF SUBMITTER:	MEI LIN WONG
SIGNATURE:	/Mei Lin Wong/
DATE SIGNED:	12/12/2016
Total Attachments: 1	
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ASSIGNMENT

WHEREAS Biao Qin of China, the assignor(s), whose mailing address/are 16-501 West Ziwei Garden, Center City, Longgang District, Shenzhen, Guangdong, China,

is the owner of the entire right, title and interest in an invention relating to and entitled LED Lampwick, LED Chip, and Method for Manufacturing LED Chip, the invention, as fully set forth and described in an application for Letters Patent and for which an application for a United States Patent was filed on 09/21/2012, Application Number 13/636,661;

AND WHEREAS Shenzhen Qin Bo Core Technology Development Co., Ltd. of China, the assignee, whose mailing address is Room 306, Park two, Shenzhen overseas students (Longgang) Venture Park, Qinglin West Road, Central city of Longgang District, Shenzhen City, Guangdong, China,

is desirous of acquiring the entire right, title and interest in and to said invention, and in and to Any Letters Patent that may be obtained therefor;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, receipt of which is hereby acknowledged, the assignors, do hereby confirm that they have sold, assigned and transferred, and do hereby sell, assign and transfer to the assignee the full and exclusive right to the said invention in the United States and their entire right, title and interest for the United States in and to the invention, together with their entire right, title and interest in and to said application, any and all divisional applications thereof, and any and all Letters Patent of the United States which may issue or be reissued for the invention;

AND the assignors hereby authorize and request the Director of the United States Patent and Trademark Office to issue to said assignee of any and all said Letters Patent not already issued as the assignee of their entire right, title and interest in and to the same, for the sole use and benefit of said assignee, its successors, assigns or legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by the assignors had this assignment and sale not been made.

AND the assignors, on behalf of themselves and their executors and administrators, hereby covenant and agree to do all such lawful acts and things and to execute without further consideration such further lawful assignments, documents, assurances, applications, and other instruments as may reasonably be required by said assignee, its successors, assigns or legal representatives, to obtain any and all Letters Patent of the United States for said invention and vest the same in said assignee, its successors, assigns or legal representatives.

ASSIGNOR

SIGNED on this [18] day of [11], 2016

Biao Qin [Signature]

Biao QIN

ASSIGNEE

SIGNED on this [18] day of [11], 2016

Biao Qin [Signature]

Biao QIN, President

On behalf of Shenzhen Qin Bo Core Technology Development Co., Ltd.